

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
120V	3.2mΩ@10V	140A

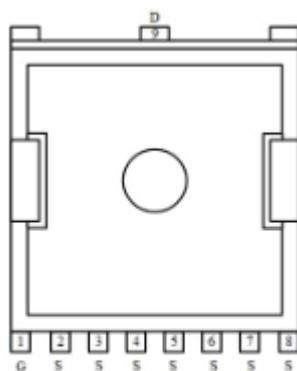
Feature

- Fast Switching
- Low Gate Charge and Rdson
- Low Reverse transfer capacitances
- 100% Single Pulse avalanche energy Test

Applications

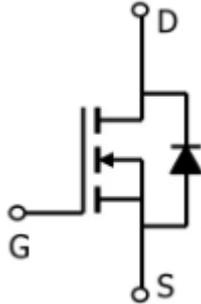
- High Speed Power switching
- DC-DC Converter
- Power Management

Package

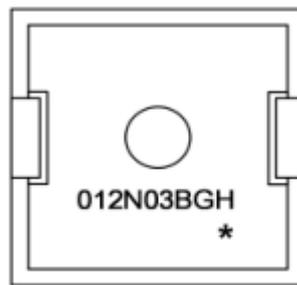


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Circuit diagram



Marking



012N03BGH : Product code
 * : Month code

Absolute maximum ratings

($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	120	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous($T_C = 25^\circ\text{C}$)	I_D	140	W
Pulsed Drain Current ²	I_{DM}	560	A
Power Dissipation ⁴ ($T_C = 25^\circ\text{C}$)	P_D	240	W
Single Pulse Avalanche Energy ¹	E_{AS}	1296	mJ
Thermal Resistance Junction- Case	$R_{\theta JC}$	0.52	$^\circ\text{C}/\text{W}$
Operation and storage temperature	T_{STG}, T_J	-55~ +150	$^\circ\text{C}$

Electrical characteristics

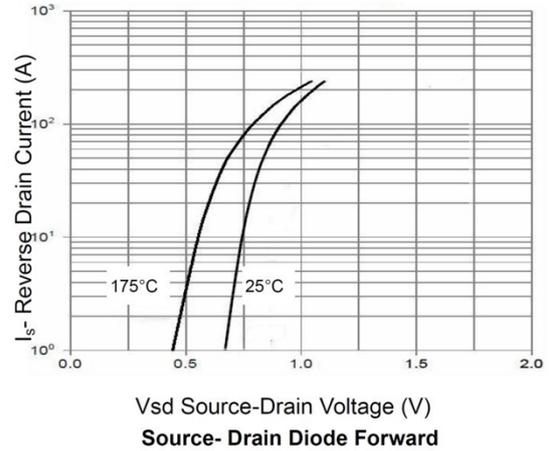
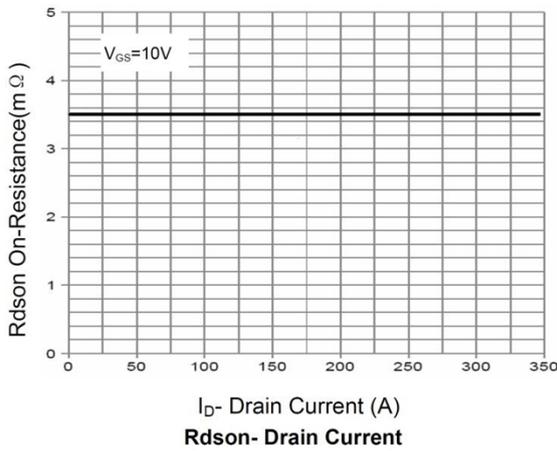
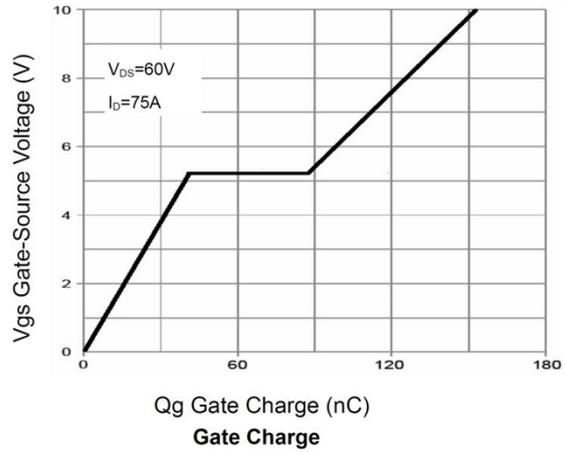
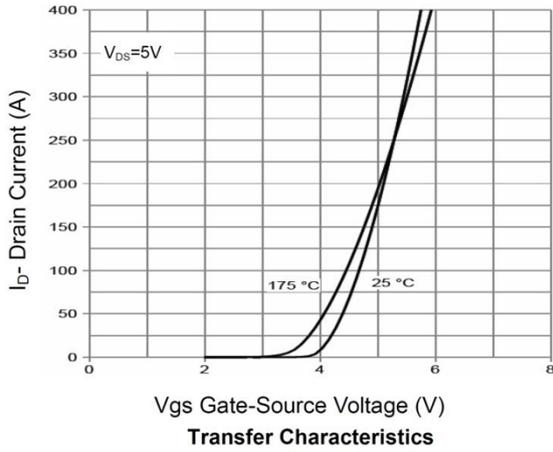
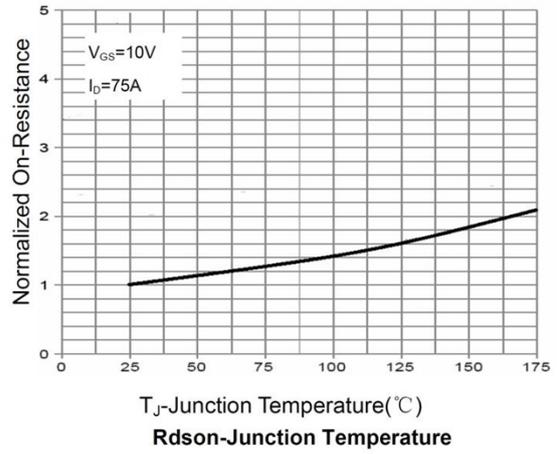
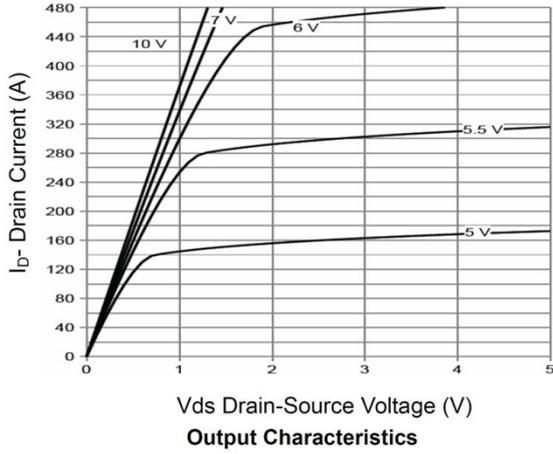
($T_A=25^\circ\text{C}$, unless otherwise noted)

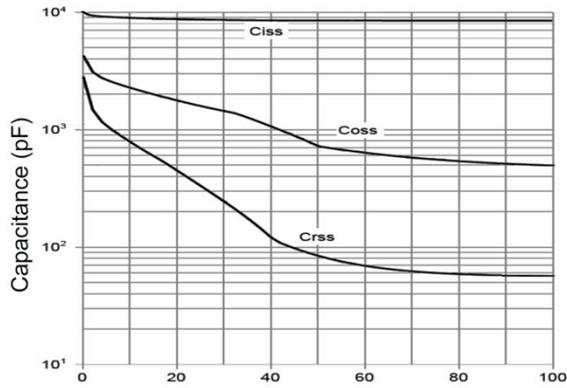
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	120			V
Drain Cut-Off Current	I_{DSS}	$V_{DS} = 96V, V_{GS} = 0V$			1	μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 0.1	μA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.6	3.1	3.6	V
Drain-Source ON Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 50A$		3.2	4	Ω
Dynamic characteristics⁴						
Input Capacitance	C_{iss}	$V_{DS} = 60V, V_{GS} = 0V,$ $f = 1MHz$		8505		pF
Output Capacitance	C_{oss}			620		
Reverse Transfer Capacitance	C_{rss}			71		
Switching Characteristics						
Total Gate Charge(4.5V)	Q_g	$V_{DS} = 60V, V_{GS} = 10V,$ $I_D = 75A$		152		nC
Gate-Source Charge	Q_{gs}			43		
Gate-Drain Charge	Q_{gd}			46		
Turn-On Delay Time	$T_{d(on)}$	$V_{GS} = 10V, V_{DS} = 50V,$ $I_D = 75A, R_G = 1.6\Omega$		25		nS
Rise Time	T_r			15		
Turn-Off Delay Time	$T_{d(off)}$			52		
Fall Time	T_f			18		
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V_{SD}	$I_S = 1A, V_{GS} = 0V$			1.2	V

Note :

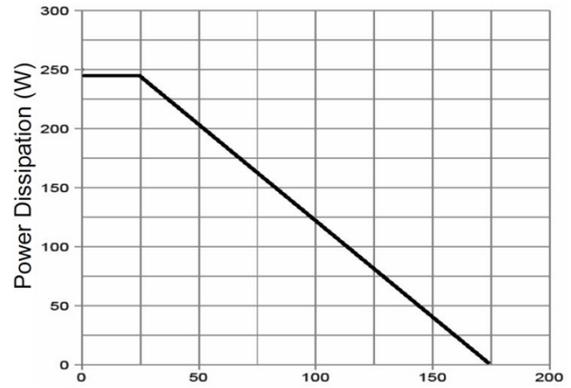
1. E_{AS} is tested at starting $T_j = 25^\circ\text{C}$, $V_{DD} = 50V, V_{GS} = 10V, L = 0.5mH, R_g = 25\Omega$;

Typical Characteristics

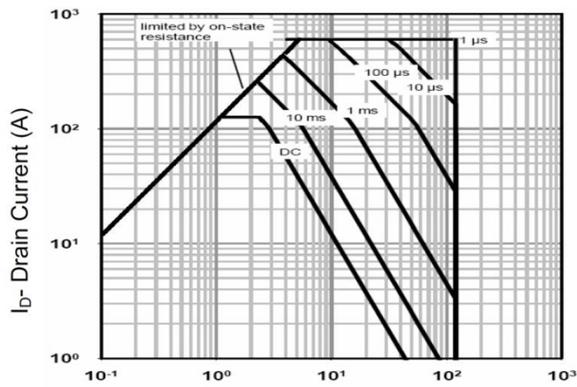




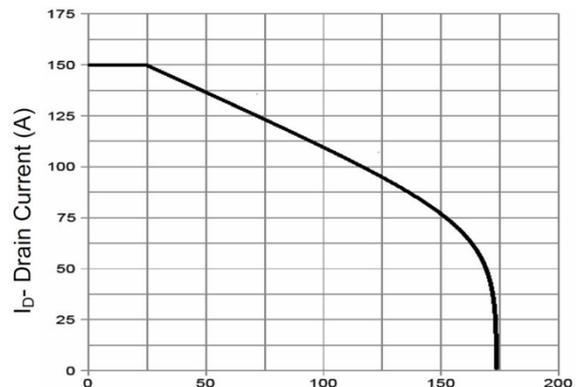
Vds Drain-Source Voltage (V)
Capacitance vs Vds



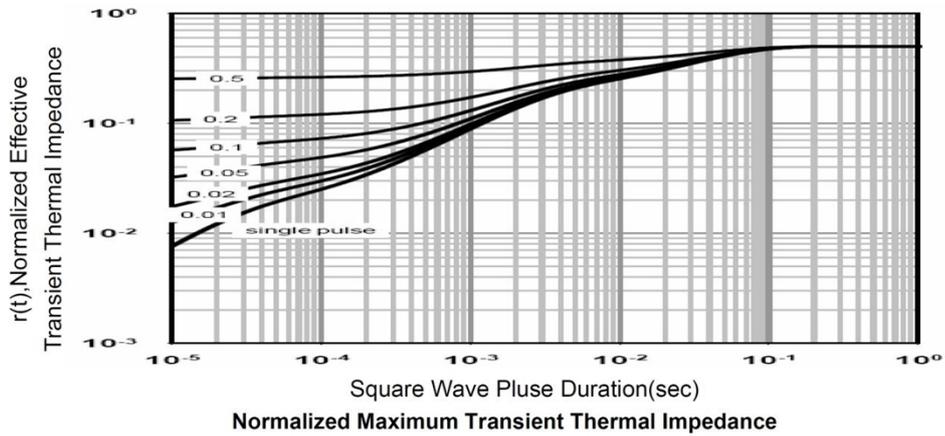
T_c-Case Temperature(°C)
Power De-rating



Vds Drain-Source Voltage (V)
Safe Operation Area



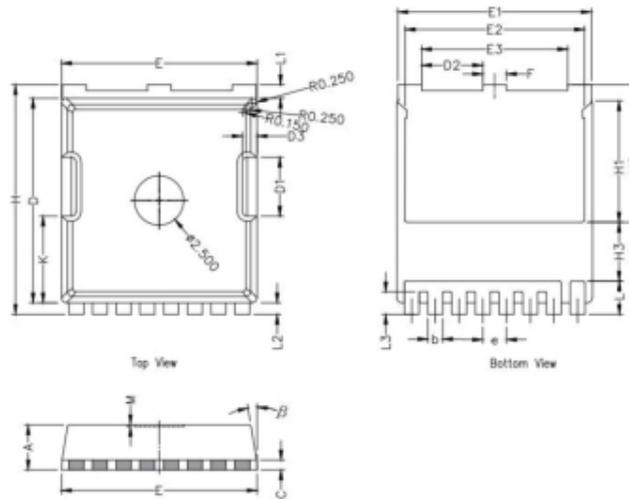
T_c-Case Temperature (°C)
Current De-rating



r(t), Normalized Effective Transient Thermal Impedance

Square Wave Pulse Duration(sec)
Normalized Maximum Transient Thermal Impedance

TOLL Package Outline Dimensions



Symbol	Dimensions In Millimeters		
	Min.	Nom.	Max.
A	2.20	2.30	2.40
b	0.65	0.75	0.85
C	0.508 REF		
D	10.25	10.40	10.55
D1	2.85	3.00	3.15
E	9.75	9.90	10.05
E1	9.65	9.80	9.95
E2	8.95	9.10	9.25
E3	7.25	7.40	7.55
e	1.20 BSC		
F	1.05	1.20	1.35
H	11.55	11.70	11.85
H1	6.03	6.18	6.33
H2	6.85	7.00	7.15
H3	3.00 BSC		
L	1.55	1.70	1.85
L1	0.55	0.7	0.85
L2	0.45	0.6	0.75
M	0.08 REF.		
β	8°	10°	12°
K	4.25	4.40	4.55